

**BYC75W-600PT2** 

Hyperfast power diode Rev.02 - 12 November 2020

**Product data sheet** 

#### 1. General description

Hyperfast power diode in a 2-lead TO247-2L plastic package.

#### 2. Features and benefits

- · Fast switching and soft reverse recovery characteristics
- Low forward voltage drop
- Low leakage current
- Low reverse recovery current
- · Reduces switching losses in associated MOSFET or IGBT

#### 3. Applications

- UPS
- EV Charger
- Welding Machine
- Air Conditioner

#### 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values				Unit
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage			6	600		V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 90 °C; Fig. 1; Fig. 2; Fig. 3	75		А		
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5 ; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 90 °C; square-wave pulse	150			A	
I <sub>FSM</sub>	non-repetitive peak forward current	$t_{\rm p}$ = 10 ms; $T_{\rm j(init)}$ = 25 °C; sine-wave pulse; <u>Fig. 4</u>	700 750			A	
		$t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse			А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 75 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	2.2	2.75	V
		I <sub>F</sub> = 75 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	- 1.6 2.1		2.1	V	
Dynamic	characteristics						
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	-	50	ns

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
		$I_F$ = 75 A; $V_R$ = 400 V; $dI_F/dt$ = 200 A/µs; $T_j$ = 25 °C; <u>Fig. 7</u>		-	42	-	ns
		$I_{F} = 75 \text{ A}; V_{R} = 400 \text{ V}; \text{ d}I_{F}/\text{d}t = 200 \text{ A}/\mu\text{s}; T_{j} = 125 ^{\circ}\text{C}; \text{ Fig. 7}$		-	106	-	ns

## 5. Pinning information

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	А	anode		K — A 001aaa020
mb	mb	mounting base; connected to cathod	С С	

## 6. Ordering information

Table 3. Ordering information									
Type number	Package	Orderable part number	Packing	Small packing	Package	Package			
	name		method	quantity	version	issue date			
BYC75W-600PT2	TO247-2L	BYC75W-600PT2Q	Tube	30	TO247L-2L	10-Nov-2020			

### 7. Marking

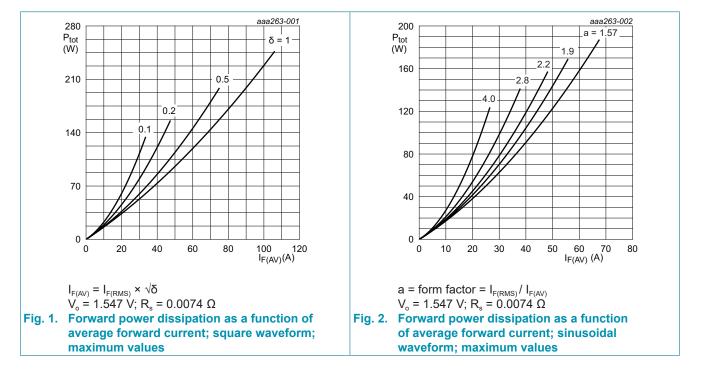
Table 4. Marking codes		
Type number	Marking codes	
BYC75W-600PT2	BYC75W	
	600PT2	

#### 8. Limiting values

#### Table 5. Limiting values

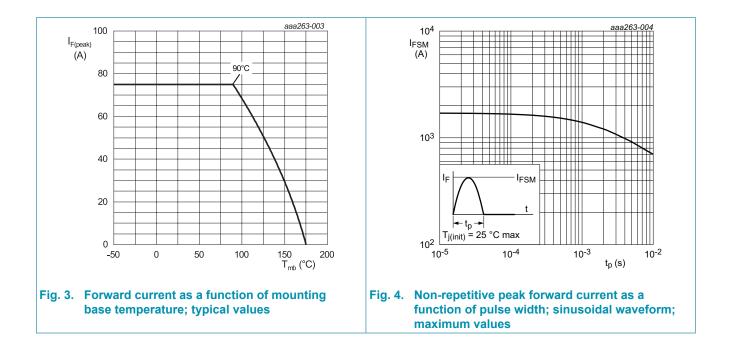
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		600	V
V <sub>RWM</sub>	crest working reverse voltage		600	V
V <sub>R</sub>	reverse voltage	DC	600	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 90 °C; Fig. 1; Fig. 2; Fig. 3	75	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 90 °C; square-wave pulse	150	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	700	A
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	750	А
T <sub>stg</sub>	storage temperature		-55 to 175	°C
T <sub>j</sub>	junction temperature		175	°C



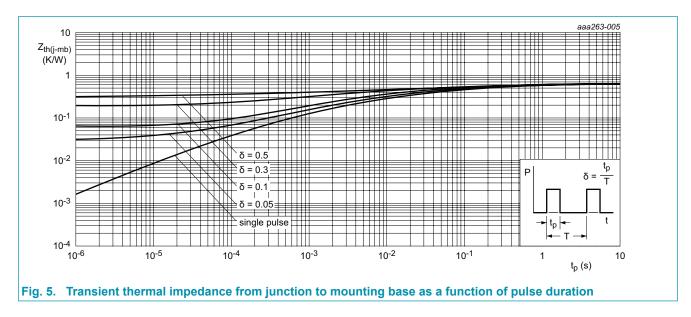
Hyperfast power diode

**BYC75W-600PT2** 



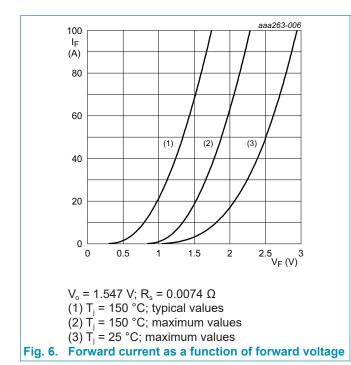
### 9. Thermal characteristics

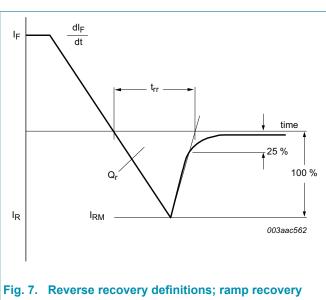
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.43	0.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



### **10. Characteristics**

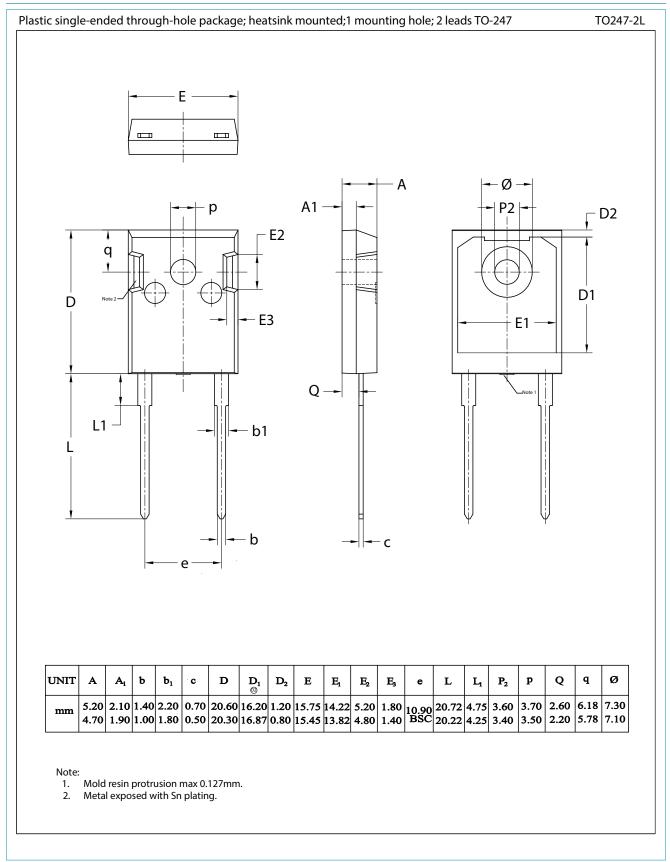
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics	· · · · · · · · · · · · · · · · · · ·				
V <sub>F</sub>	forward current	I <sub>F</sub> = 75 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	2.2	2.75	V
		I <sub>F</sub> = 75 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	1.6	2.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 125 °C	-	-	1	mA
Dynamic	characteristics	· · · ·				
Qr	reverse charge	$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	85	-	nC
		$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	640	-	nC
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	50	ns
		$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	42	-	ns
		$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	106	-	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	4.1	-	А
		I <sub>F</sub> = 75 A; V <sub>R</sub> = 400 V; dI <sub>F</sub> /dt = 200 A/μs; T <sub>i</sub> = 125 °C; <u>Fig. 7</u>	-	12.2	-	А





#### BYC75W-600PT2 Hyperfast power diode

#### **11. Package outline**



BYC75W-600PT2 Product data sheet

# BYC75W-600PT2

#### Hyperfast power diode

## 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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